

Description

The STD35P6LLF6 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

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TO-252-2L (DPAK)

General Features

V_{DS} =- 60V, I_D =-30A

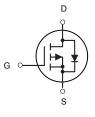
 $R_{DS(ON)} < 33m\Omega$ @ V_{GS} =-10V

Application

PWM applications

Load switch

Power management



P-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
STD35P6LLF6	TO-252-2L(DPAK)	HXY MOSFET	2500

Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	-60	V
V _{GS}	Gate-Source Voltage (V _{DS} =0V)	±20	V
I-	Drain Current-Continuous(Tc=25°C)	-30	А
l _D	Drain Current-Continuous(Tc=100°C)	-25.5	Α
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-144	Α
D-	Maximum Power Dissipation(Tc=25°C)	79	W
P _D	Maximum Power Dissipation(Tc=100°C)	39.5	W
Eas	Avalanche energy (Note 2)	196	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 175	°C



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250μA	-60			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-60V, V _{GS} =0V			-1	μA
Igss	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1	-1.8	-2.5	V
g FS	Forward Transconductance	V _{DS} =-5V, I _D =-15A		35		S
Rds(on)	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-15A		29	33	mΩ
		V _{GS} =-4.5V, I _D =-10A		35	46	mΩ
Ciss	Input Capacitance			4026		pF
Coss	Output Capacitance	V _{DS} =-25V, V _{GS} =0V, f=1.0MHz		134		pF
Crss	Reverse Transfer Capacitance			98		pF
$t_{d(on)}$	Turn-on Delay Time			12.2		nS
tr	Turn-on Rise Time	V _{GS} =-10V, V _{DS} =-30V,		10		nS
t _{d(off)}	Turn-Off Delay Time	$R_L=1.5\Omega$, $R_{GEN}=3\Omega$		64		nS
t _f	Turn-Off Fall Time			14		nS
Qg	Total Gate Charge			68		nC
Qgs	Gate-Source Charge	V _{GS} =-10V, V _{DS} =-30V, I _D =-20A		10.5		nC
Q_{gd}	Gate-Drain Charge			13		nC
I _{SD}	Source-Drain Current (Body Diode)				30	Α
VsD	Forward on Voltage (Note 3)	V _G s=0V, Is=-15A			-1.2	V
trr	Reverse Recovery Time	I _F =-20A, di/dt=100A/μs	26			ns
Qrr	Reverse Recovery Charge	I _F =-20A, di/dt=100A/μs		29		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: T_J =25°C, V_{DD} =40V, V_G =-10V, Rg=25 Ω , L=0.5mH. Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



Typical Electrical And Thermal Characteristics (Curves)

Figure 1. Output Characteristics

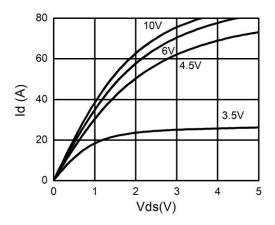


Figure 3. Power Dissipation

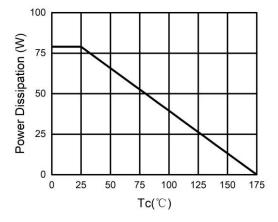


Figure 5. BV_{DSS} vs Junction Temperature

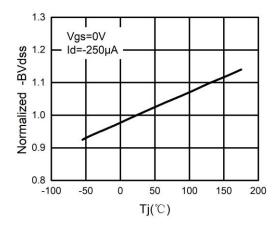


Figure 2. Transfer Characteristics

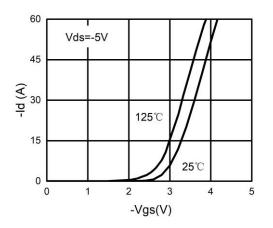


Figure 4. Drain Current

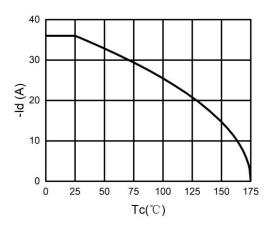


Figure 6. R_{DS(ON)} vs Junction Temperature

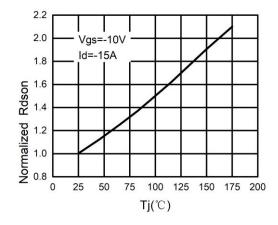


Figure 7. Gate Charge Waveforms

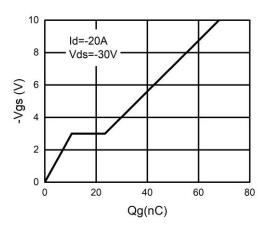


Figure 8. Capacitance

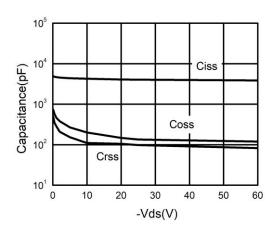


Figure 9. Body-Diode Characteristics

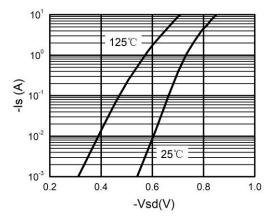
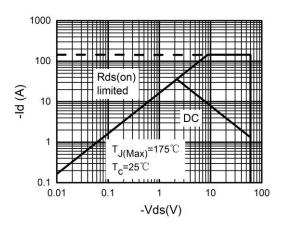
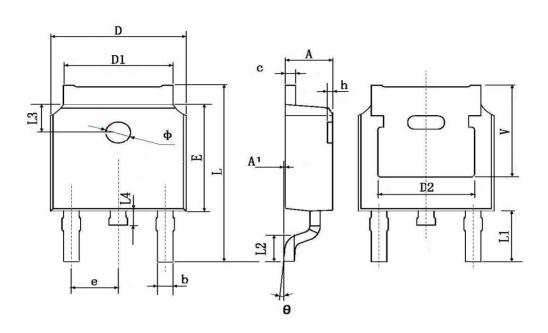


Figure 10. Maximum Safe Operating Area



TO-252-2L(DPAK) Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches			
	Min.	Max.	Min.	Max.		
Α	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	4.830 TYP.		0.190 TYP.			
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067		
L3	1.600	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039		
Ф	1.100	1.300	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.000	0.300	0.000	0.012		
V	5.350 TYP.		0.211 TYP.			



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